

# 74ACT534

## Octal D-Type Flip-Flop with 3-STATE Outputs

### Features

- $I_{CC}$  and  $I_{OZ}$  reduced by 50%
- Edge-triggered D-type inputs
- Buffered positive edge-triggered clock
- 3-STATE outputs for bus-oriented applications
- Outputs source/sink 24mA
- ACT534 has TTL-compatible inputs
- Inverted output version of ACT374

### General Description

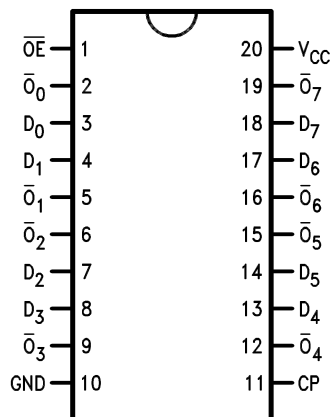
The ACT534 is a high-speed, low-power octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-STATE outputs for bus-oriented applications. A buffered Clock (CP) and Output Enable ( $\overline{OE}$ ) are common to all flip-flops. The ACT534 is the same as the ACT374 except that the outputs are inverted.

### Ordering Information

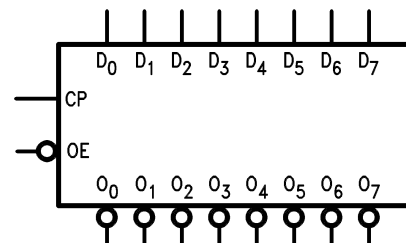
Order Number	Package Number	Package Description
74ACT534SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body
74ACT534SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

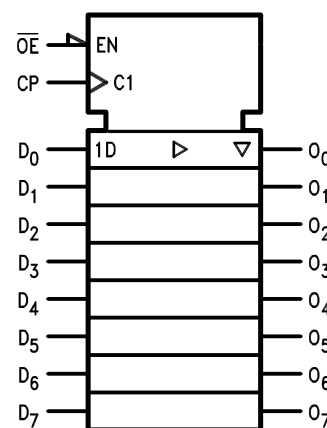
### Connection Diagram



### Logic Symbols



IEEE/IEC



### Pin Descriptions

Pin Names	Description
$D_0$ - $D_7$	Data Inputs
CP	Clock Pulse Input
$\overline{OE}$	3-STATE Output Enable Input
$\overline{O}_0$ - $\overline{O}_7$	Complementary 3-STATE Outputs

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### Functional Description

The ACT534 consists of eight edge-triggered flip-flops with individual D-type inputs and 3-STATE complementary outputs. The buffered clock and buffered Output Enable are common to all flip-flops. The eight flip-flops will store the state of their individual D inputs that meet the setup and hold times requirements on the LOW-to-HIGH Clock (CP) transition. With the Output Enable ( $\overline{OE}$ ) LOW, the contents of the eight flip-flops are available at the outputs. When the  $\overline{OE}$  is HIGH, the outputs go to the high impedance state. Operation of the  $\overline{OE}$  input does not affect the state of the flip-flops.

### Function Table

Inputs			Output
CP	OE	D	$\overline{O}$
↗	L	H	L
↗	L	L	H
L	L	X	$\overline{O}_0$
X	H	X	Z

H = HIGH Voltage Level

L = LOW Voltage Level

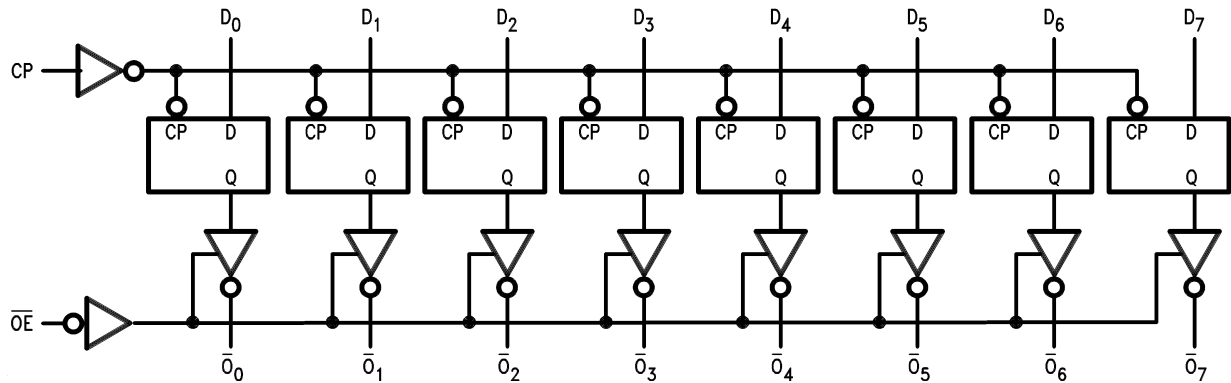
X = Immaterial

↗ = LOW-to-HIGH Clock Transition

Z = High Impedance

$\overline{O}_0$  = Value stored from previous clock cycle

### Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 1.

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
$V_{CC}$	Supply Voltage	-0.5V to +7.0V
$I_{IK}$	DC Input Diode Current $V_I = -0.5V$ $V_I = V_{CC} + 0.5V$	-20mA +20mA
$V_I$	DC Input Voltage	-0.5V to $V_{CC} + 0.5V$
$I_{OK}$	DC Output Diode Current $V_O = -0.5V$ $V_O = V_{CC} + 0.5V$	-20mA +20mA
$V_O$	DC Output Voltage	-0.5V to $V_{CC} + 0.5V$
$I_O$	DC Output Source or Sink Current	$\pm 50mA$
$I_{CC}$ or $I_{GND}$	DC $V_{CC}$ or Ground Current per Output Pin	$\pm 50mA$
$T_{STG}$	Storage Temperature	-65°C to +150°C
$T_J$	Junction Temperature	140°C

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
$V_{CC}$	Supply Voltage	4.5V to 5.5V
$V_I$	Input Voltage	0V to $V_{CC}$
$V_O$	Output Voltage	0V to $V_{CC}$
$T_A$	Operating Temperature	-40°C to +85°C
$\Delta V / \Delta t$	Minimum Input Edge Rate: $V_{IN}$ from 0.8V to 2.0V, $V_{CC}$ @ 4.5V, 5.5V	125mV/ns

## DC Electrical Characteristics

Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to +85°C		Units	
				Typ.	Guaranteed Limits				
V <sub>IH</sub>	Minimum HIGH Level Input Voltage	4.5	V <sub>OUT</sub> = 0.1V or V <sub>CC</sub> - 0.1V	1.5	2.0	2.0		V	
		5.5		1.5	2.0	2.0			
V <sub>IL</sub>	Maximum LOW Level Input Voltage	4.5	V <sub>OUT</sub> = 0.1V or V <sub>CC</sub> - 0.1V	1.5	0.8	0.8		V	
		5.5		1.5	0.8	0.8			
V <sub>OH</sub>	Minimum HIGH Level Output Voltage	4.5	I <sub>OUT</sub> = -50μA	4.49	4.4	4.4		V	
		5.5		5.49	5.4	5.4			
		4.5	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> ; I <sub>OH</sub> = -24mA			3.86	3.76		
		5.5	I <sub>OH</sub> = -24mA <sup>(1)</sup>			4.86	4.76		
V <sub>OL</sub>	Maximum LOW Level Output Voltage	4.5	I <sub>OUT</sub> = 50μA	0.001	0.1	0.1		V	
		5.5		0.001	0.1	0.1			
		4.5	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> ; I <sub>OL</sub> = 24mA			0.36	0.44		
		5.5	I <sub>OL</sub> = 24mA <sup>(1)</sup>			0.36	0.44		
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	V <sub>I</sub> = V <sub>CC</sub> , GND		±0.1	±1.0		μA	
I <sub>OZ</sub>	Maximum 3-STATE Current	5.5	V <sub>I</sub> = V <sub>IL</sub> , V <sub>IH</sub> ; V <sub>O</sub> = V <sub>CC</sub> , GND		±0.25	±2.5		μA	
I <sub>CCT</sub>	Maximum I <sub>CC</sub> /Input	5.5	V <sub>I</sub> = V <sub>CC</sub> - 2.1V	0.6		1.5		mA	
I <sub>OLD</sub>	Minimum Dynamic Output Current <sup>(2)</sup>	5.5	V <sub>OLD</sub> = 1.65V Max.			75		mA	
I <sub>OHD</sub>		5.5	V <sub>OHD</sub> = 3.85V Min.			-75		mA	
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	V <sub>IN</sub> = V <sub>CC</sub> or GND		4.0	40.0		μA	

**Notes:**

1. All outputs loaded; thresholds on input associated with output under test.
2. Maximum test duration 2.0ms, one output loaded at a time.

## AC Electrical Characteristics

Symbol	Parameter	$V_{CC}$ (V) <sup>(3)</sup>	$T_A = +25^\circ\text{C}$ , $C_L = 50\text{pF}$			$T_A = -40^\circ\text{C to } +85^\circ\text{C}$ , $C_L = 50\text{pF}$		Units
			Min.	Typ.	Max.	Min.	Max.	
$f_{MAX}$	Maximum Clock Frequency	5.0		100		120		MHz
$t_{PLH}$	Propagation Delay, CP to $\overline{Q}_n$	5.0	2.5	6.5	11.5	2.0	12.5	ns
$t_{PHL}$	Propagation Delay, CP to $\overline{Q}_n$	5.0	2.0	6.0	10.5	2.0	12.0	ns
$t_{PZH}$	Output Enable Time	5.0	2.5	6.5	12.0	2.0	12.5	ns
$t_{PZL}$	Output Enable Time	5.0	2.0	6.0	11.0	2.0	11.5	ns
$t_{PHZ}$	Output Disable Time	5.0	1.5	7.0	12.5	1.0	13.5	ns
$t_{PLZ}$	Output Disable Time	5.0	1.5	5.5	10.5	1.0	10.5	ns

### Note:

3. Voltage range 5.0 is  $5.0\text{V} \pm 0.5\text{V}$ .

## AC Operating Requirements

Symbol	Parameter	$V_{CC}$ (V) <sup>(4)</sup>	$T_A = +25^\circ\text{C}$ , $C_L = 50\text{pF}$		$T_A = -40^\circ\text{C to } +85^\circ\text{C}$ , $C_L = 50\text{pF}$		Units
			Typ.	Guaranteed Minimum	Typ.	Guaranteed Minimum	
$t_S$	Setup Time, HIGH or LOW, $D_n$ to CP	5.0	1.0	3.5	4.0		ns
$t_H$	Hold Time, HIGH or LOW, $D_n$ to CP	5.0	-1.0	1.0	1.5		ns
$t_W$	CP Pulse Width, HIGH or LOW	5.0	2.0	3.5	3.5		ns

### Note:

4. Voltage range 5.0 is  $5.0\text{V} \pm 0.5\text{V}$ .

## Capacitance

Symbol	Parameter	Conditions	Typ.	Units
$C_{IN}$	Input Capacitance	$V_{CC} = \text{OPEN}$	4.5	pF
$C_{PD}$	Power Dissipation Capacitance	$V_{CC} = 5.0\text{V}$	40.0	pF

## Physical Dimensions

Dimensions are in inches (millimeters) unless otherwise noted.

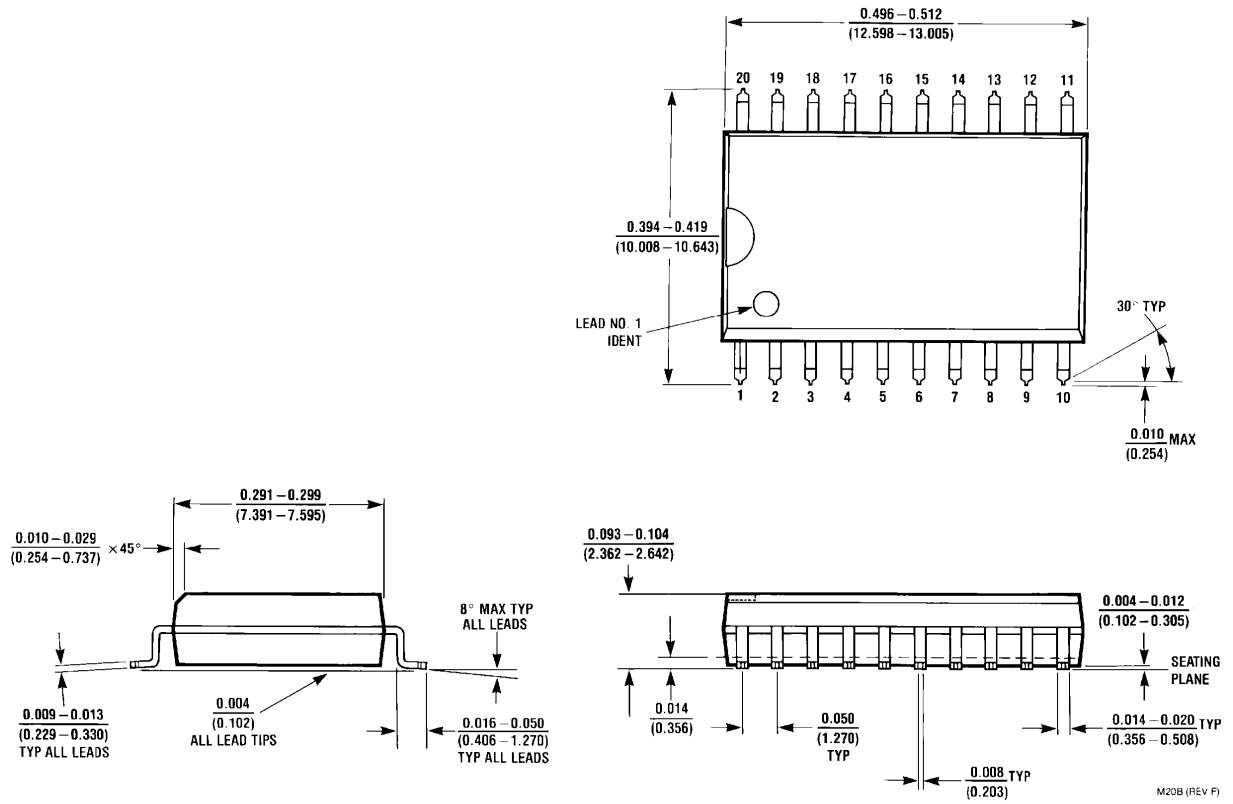
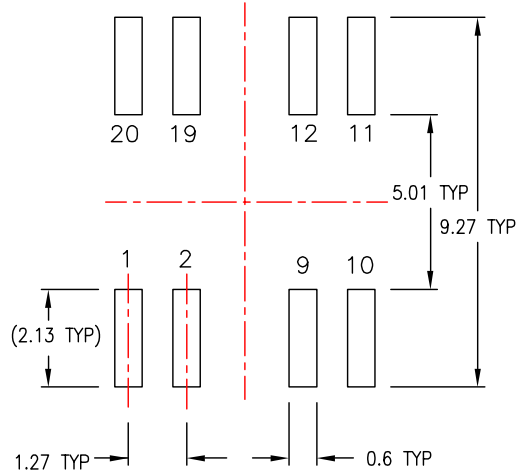
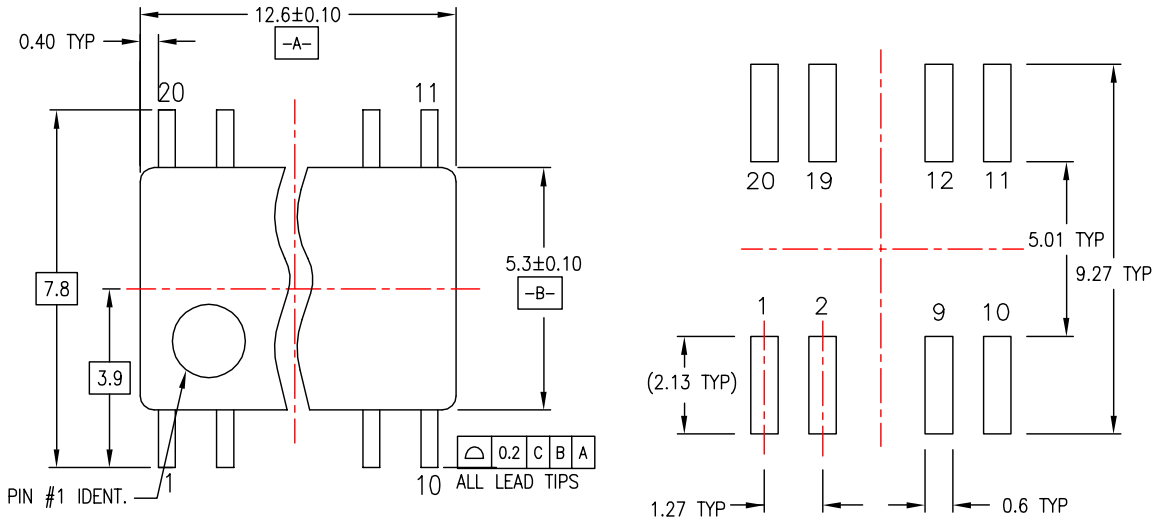


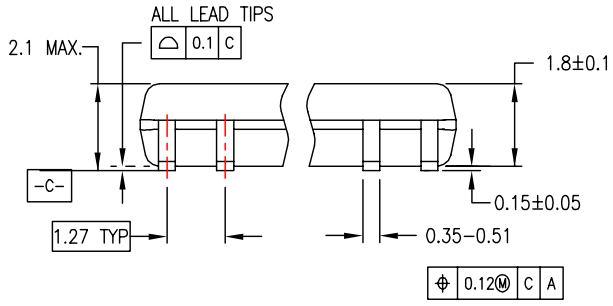
Figure 2. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Package Number M20B

**Physical Dimensions** (Continued)

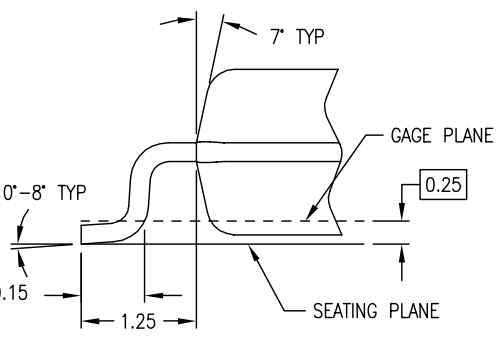
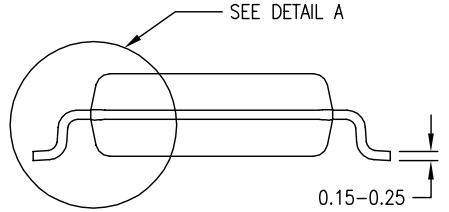
Dimensions are in millimeters unless otherwise noted.



LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS



DETAIL A


- NOTES:
- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
  - B. DIMENSIONS ARE IN MILLIMETERS.
  - C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M20DREVC

**Figure 3. 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M20D**

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Rev. I24